BAV70DXV6T1, **BAV70DXV6T5**

Preferred Device

Monolithic Dual Switching Diode Common Cathode

Features

• These are Pb-Free Devices

MAXIMUM RATINGS (EACH DIODE)

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	70	Vdc
Forward Current	١ _F	200	mAdc
Peak Forward Surge Current	I _{FM(surge)}	500	mAdc

THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation, $T_A = 25^{\circ}C$ Derate above 25°C	P _D	357 (Note 1) 2.9 (Note 1)	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	°C/W
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation, T _A = 25°C	Р		
Derate above 25°C	P _D	500 (Note 1) 4.0 (Note 1)	mW mW/°C
Derate above 25°C Thermal Resistance, Junction-to-Ambient	PD R _{θJA}	(Note 1) 4.0	

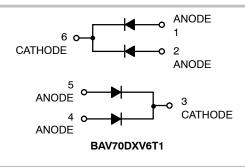
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

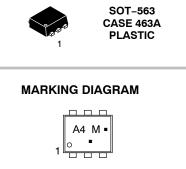
1. FR-4 @ Minimum Pad



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http://onsemi.com





A4 = Specific Device Code M = Month Code . = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BAV70DXV6T1	SOT-563*	4000/Tape & Reel
BAV70DXV6T1G	SOT-563*	4000/Tape & Reel
BAV70DXV6T5	SOT-563*	8000/Tape & Reel
BAV70DXV6T5G	SOT-563*	8000/Tape & Reel

+For information on tape and reel specifications,

including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*These packages are inherently Pb-Free.

Preferred devices are recommended choices for future use and best overall value.

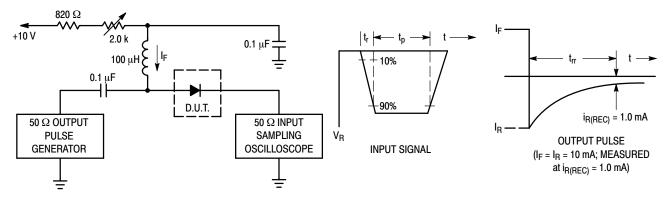
BAV70DXV6T1, BAV70DXV6T5

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (EACH DIODE)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Reverse Breakdown Voltage (Note 2)	V _(BR)	70	_	Vdc

($I_{(BR)} = 100 \ \mu Adc$)		V _(BR)	70	-	Vac
Reverse Voltage Leakage Current (Note 2) ($V_R = 25 \text{ Vdc}, T_J = 150^{\circ}\text{C}$) ($V_R = 70 \text{ Vdc}$) ($V_R = 70 \text{ Vdc}, T_J = 150^{\circ}\text{C}$)		I _R	- - -	60 2.5 100	μAdc
Diode Capacitance (Note 2) (V _R = 0, f = 1.0 MHz)		C _D	-	1.5	pF
Forward Voltage (Note 2) $(I_F = 1.0 \text{ mAdc})$ $(I_F = 10 \text{ mAdc})$ $(I_F = 50 \text{ mAdc})$ $(I_F = 150 \text{ mAdc})$		V _F	- - - -	715 855 1000 1250	mVdc
Reverse Recovery Time (Note 2) ($I_F = I_R = 10$ mAdc, $V_R = 5.0$ Vdc, $I_{R(REC)} = 1.0$ mAdc) (Figure 1)	R _L = 100 Ω	t _{rr}	-	6.0	ns

2. For each individual diode while second diode is unbiased.



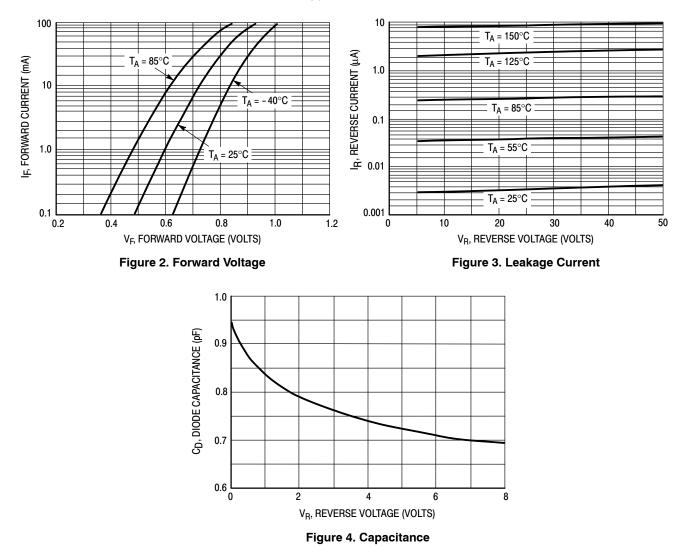
Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA. 2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA.

3. t_p » t_{rr}

Figure 1. Recovery Time Equivalent Test Circuit

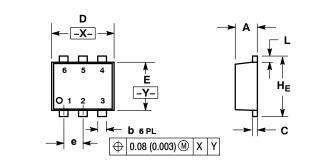
BAV70DXV6T1, BAV70DXV6T5

Curves Applicable to Each Anode



PACKAGE DIMENSIONS

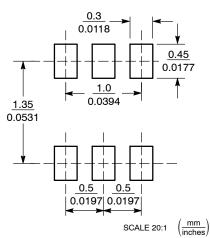
SOT-563, 6 LEAD CASE 463A-01 **ISSUE F**



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETERS 2
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS З. IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.50	0.55	0.60	0.020	0.021	0.023	
b	0.17	0.22	0.27	0.007	0.009	0.011	
С	0.08	0.12	0.18	0.003	0.005	0.007	
D	1.50	1.60	1.70	0.059	0.062	0.066	
Е	1.10	1.20	1.30	0.043	0.047	0.051	
е	0.5 BSC			0	0.02 BSC)	
L	0.10	0.20	0.30	0.004	0.008	0.012	
HE	1.50	1.60	1.70	0.059	0.062	0.066	

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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